



Power MOSFETS

DATASHEET

LM30120NAK8A

N-Channel
Enhancement Mode MOSFET

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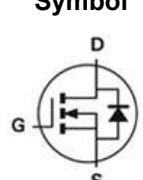
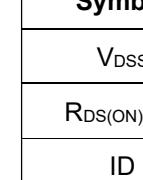


Quality Management Systems
ISO 9001:2015 Certificate

LM30120NAK8A

N-Channel Enhancement Mode MOSFET

Pin Description

PDFN5*6 (TOP view)	Symbol	Symbol	N-Channel	Unit	
			V _{DSS}	30	V
			R _{DS(ON)-Max}	12	mΩ
			I _D	46	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

Product Summary

Symbol	N-Channel	Unit
V _{DSS}	30	V
R _{DS(ON)-Max}	12	mΩ
I _D	46	A

Applications

- DC-DC Converters
- Portable equipment application

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM30120NAK8A	PDFN5*6	Tape & Reel	5000 / Tape & Reel	30120 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note : = Lot Code

Absolute Maximum Ratings (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V _{DSS}	Drain-Source Voltage	30	V
V _{GSS}	Gate-Source Voltage	±20	
T _J	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
I _S	Diode Continuous Forward Current	T _c =25°C 23	A
I _{DM} ^①	Pulse Drain Current Tested	T _c =25°C 52	A
I _D	Continuous Drain Current	T _c =25°C 46 T _c =100°C 29	A
P _D	Maximum Power Dissipation	T _c =25°C 25.5 T _c =100°C 10.2	W
I _D	Continuous Drain Current	T _A =25°C 12.2 T _A =70°C 9.8	A
P _D	Maximum Power Dissipation	T _A =25°C 1.8 T _A =70°C 1.1	W
I _{AS} ^②	Avalanche Current, Single pulse	L=0.1mH 19 L=0.5mH 10	A
E _{AS} ^③	Avalanche Energy, Single pulse	L=0.1mH 18 L=0.5mH 25	mJ

Thermal Characteristics

Symbol	Parameter	Rating	Unit
R _{θJC}	Thermal Resistance-Junction to Case	Steady State 4.9	°C/W
R _{θJA} ^③	Thermal Resistance-Junction to Ambient	Steady State 70	°C/W

Note ① : Max. current is limited by bonding wire

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

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N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{DS}}=250\mu\text{A}$	30	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=24\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{DS}}=250\mu\text{A}$	1.1	1.6	2.1	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\circledast}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{DS}}=10\text{A}$	-	10	12	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{DS}}=6\text{A}$	-	12	16	
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}, I_{\text{DS}}=5\text{A}$	-	9	-	S
Dynamic Characteristics [®]						
R_{G}	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V},$ $\text{Freq.}=1\text{MHz}$	-	3	-	Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V},$ $V_{\text{DS}}=15\text{V},$ $\text{Freq.}=1\text{MHz}$	-	872	-	pF
C_{oss}	Output Capacitance		-	112	-	
C_{rss}	Reverse Transfer Capacitance		-	104	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=15\text{V},$ $I_{\text{D}}=1\text{A}, R_{\text{GEN}}=6\Omega$	-	17	-	nS
t_{r}	Turn-on Rise Time		-	30	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	30	-	
t_{f}	Turn-off Fall Time		-	16	-	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=4.5\text{V}, V_{\text{DS}}=15\text{V}$ $I_{\text{D}}=10\text{A}$	-	10.3	-	nC
Q_{g}	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=15\text{V},$ $I_{\text{D}}=10\text{A}$	-	20.5	-	
Q_{gs}	Gate-Source Charge		-	2.32	-	
Q_{gd}	Gate-Drain Charge		-	4.8	-	
Source-Drain Characteristics						
$V_{\text{SD}}^{\circledast}$	Diode Forward Voltage	$I_{\text{SD}}=1\text{A}, V_{\text{GS}}=0\text{V}$	-	0.75	1.1	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=1\text{A}, V_{\text{R}}=20\text{V}$	-	25.4	-	nS
Q_{rr}	Reverse Recovery Charge	$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	10.7	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

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N-Channel Typical Characteristics

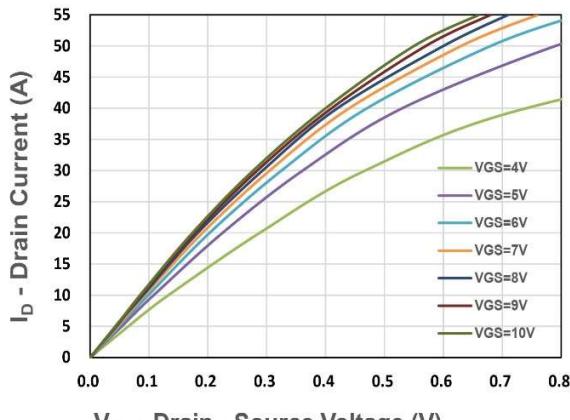


Figure 1. Output Characteristics

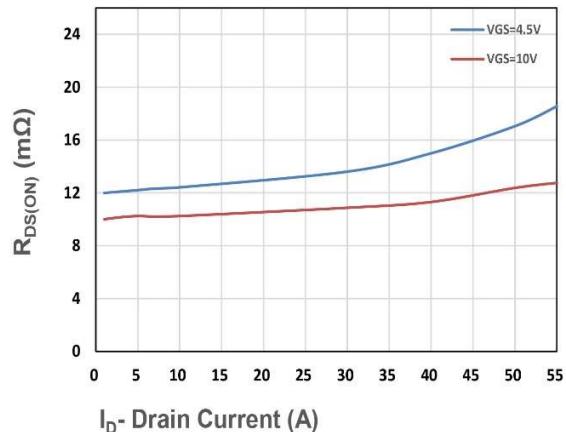


Figure 2. On-Resistance vs. ID

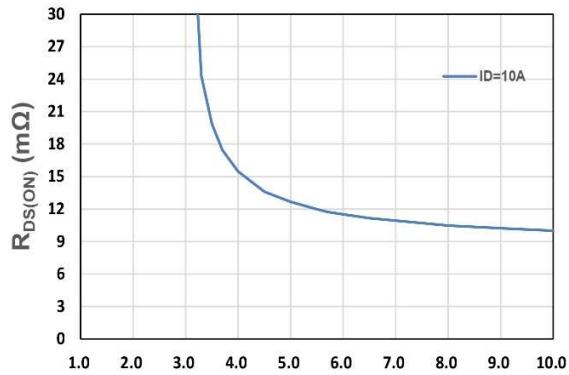


Figure 3. On-Resistance vs. VGS

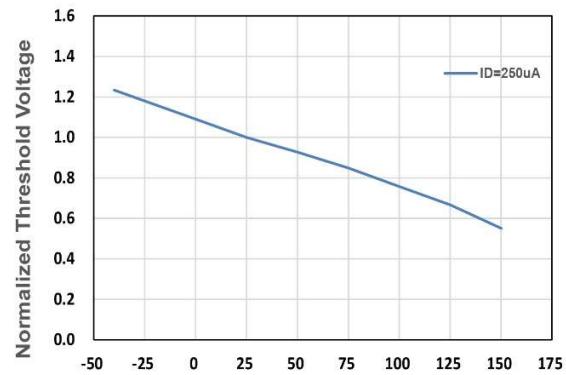


Figure 4. Gate Threshold Voltage

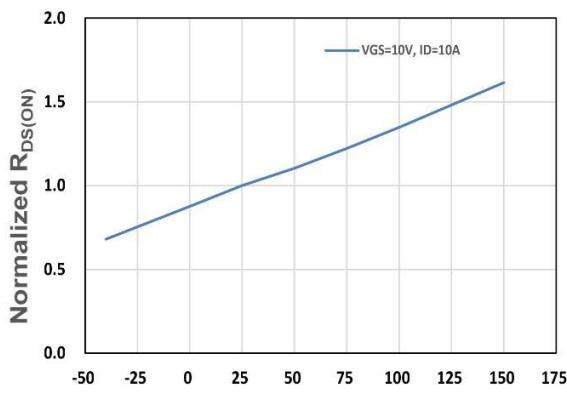


Figure 5. Drain-Source On Resistance

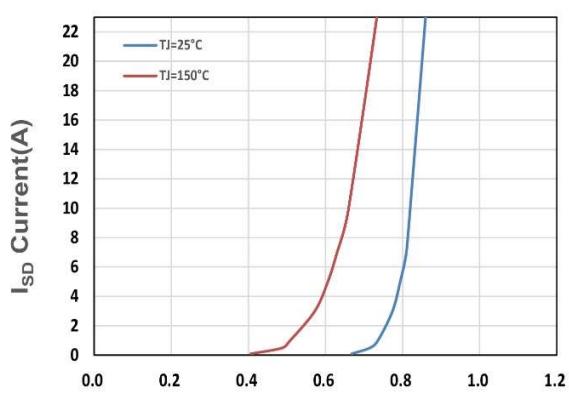
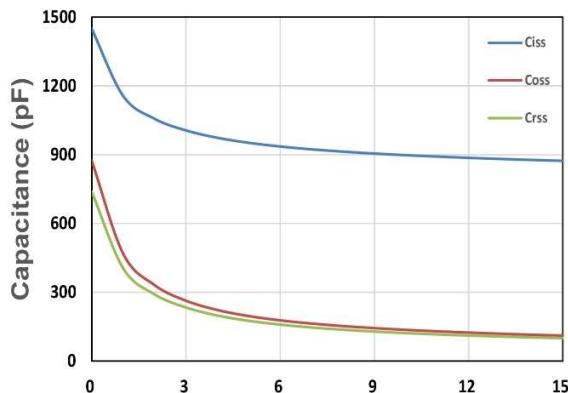
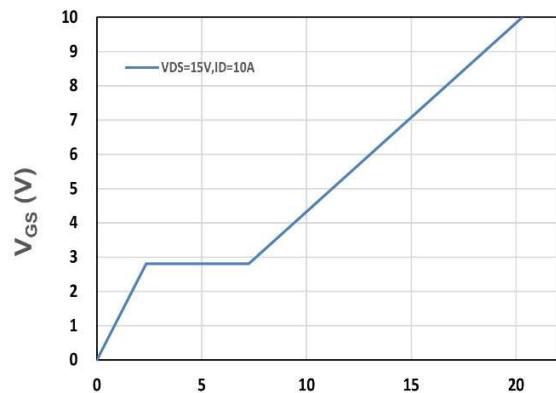


Figure 6. Source-Drain Diode Forward

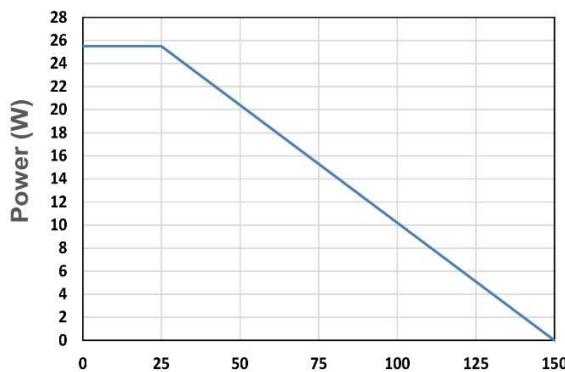
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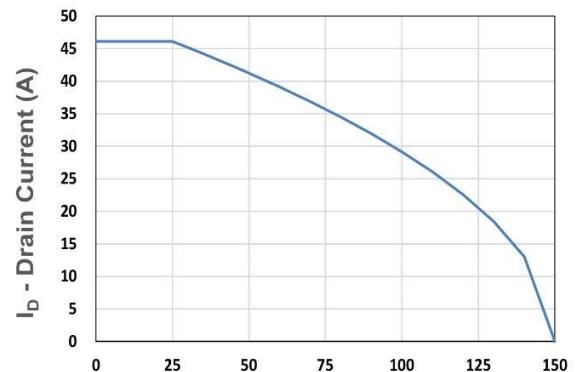
V_{DS} - Drain - Source Voltage (V)
Figure 7. Capacitance



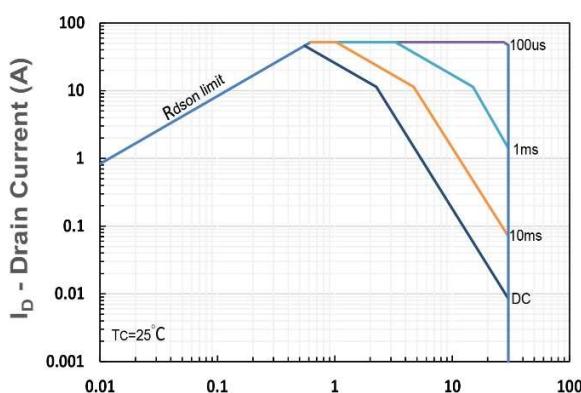
Q_g , Total Gate Charge (nC)
Figure 8. Gate Charge Characteristics



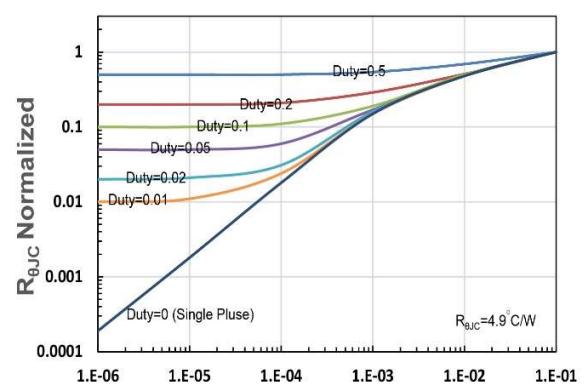
T_c - Case Temperature (°C)
Figure 9. Power Dissipation



I_D - Drain Current (A)
Figure 10. Drain Current



V_{DS} - Drain-Source Voltage (V)
Figure 11. Safe Operating Area



t_1 , Square Wave Pulse Duration(s)
Figure 12. $R_{\theta JC}$ Transient Thermal Impedance